

PBSS4330X,115 Datasheet

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DiGi Electronics Part Number
Manufacturer
Manufacturer Product Number
Description
Detailed Description

PBSS4330X,115-DG

Nexperia USA Inc.

PBSS4330X,115

TRANS NPN 30V 3A SOT89

Bipolar (BJT) Transistor NPN 30 V 3 A 100MHz 1.6 W Surface Mount SOT-89

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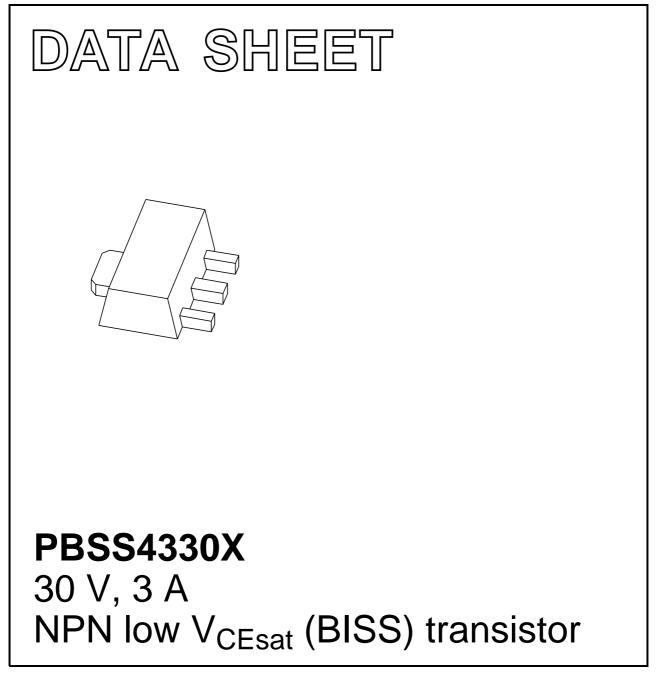
Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
PBSS4330X,115	Nexperia USA Inc.
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
NPN	3 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
30 V	300mV @ 300mA, 3A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
100nA	270 @ 1A, 2V
Power - Max:	Frequency - Transition:
1.6 W	100MHz
Operating Temperature:	Grade:
150°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q100	Surface Mount
Package / Case:	Supplier Device Package:
TO-243AA	SOT-89
Base Product Number:	
PBSS4330	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0075	

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2003 Nov 28 2004 Dec 06



NXP Semiconductors

30 V, 3 A NPN low V_{CEsat} (BISS) transistor

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT89 plastic package.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS4330X	*1R

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.

* = W: Made in China.

ORDERING INFORMATION

TYPE NUMBER		PACKAGE	
	NAME	DESCRIPTION	VERSION
PBSS4330X	SC-62	plastic surface mounted package; collector pad for good heat transfer; 3 leads	SOT89

QUICK REFERENCE DATA

,	-		-
SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	30	V
I _C	collector current (DC)	3	А
I _{CM}	peak collector current	5	А
R _{CEsat}	equivalent on-resistance	100	mΩ

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	

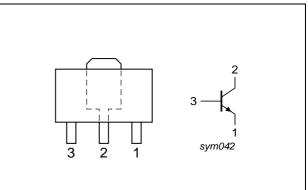


Fig.1 Simplified outline (SOT89) and symbol.

Product data sheet

PBSS4330X

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	30	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current (DC)	note 4	-	3	A
I _{CM}	peak collector current	limited by T _{j(max)}	-	5	A
I _B	base current (DC)		-	0.5	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
		note 1	-	550	mW
		note 2	-	1	W
		note 3	_	1.4	W
		note 4	-	1.6	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

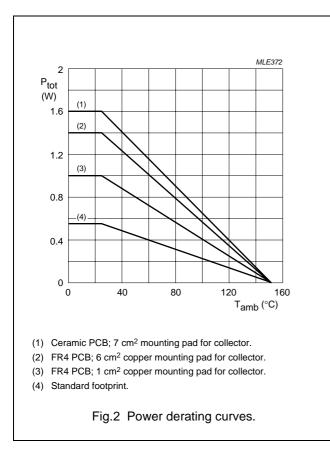
Notes

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.

2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².

3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².

4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.



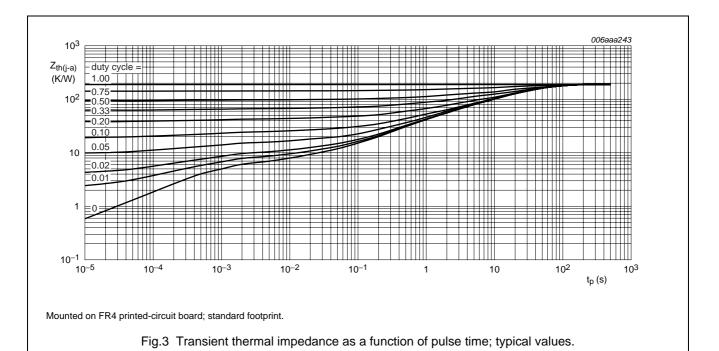
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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
		note 3	90	K/W
		note 4	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

Notes

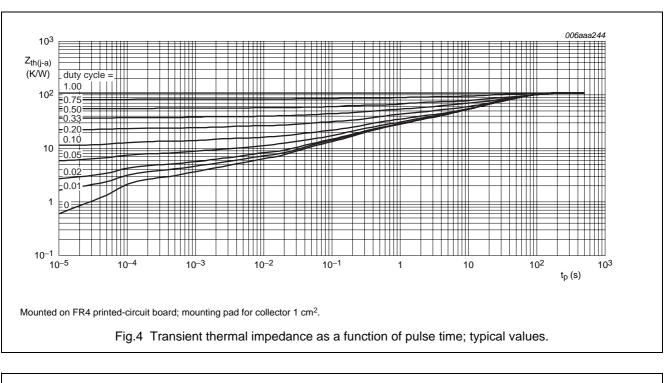
- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².
- 3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².
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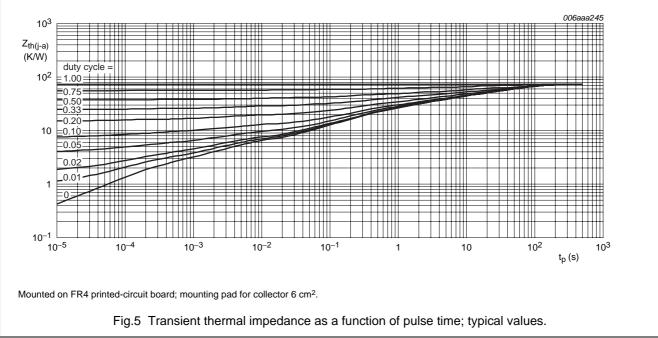


NXP Semiconductors

Product data sheet

30 V, 3 A NPN low V_{CEsat} (BISS) transistor





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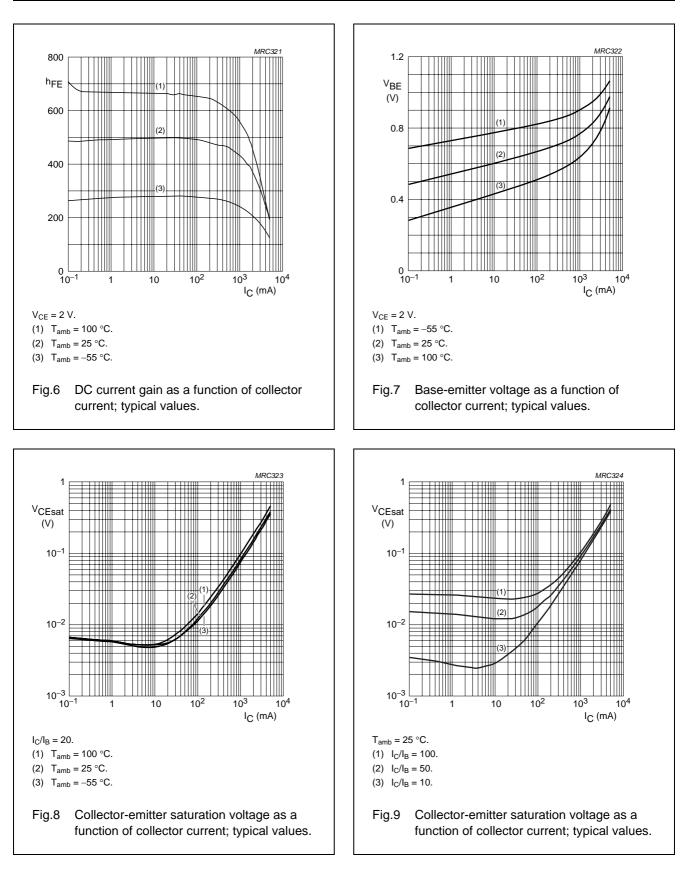
CHARACTERISTICS

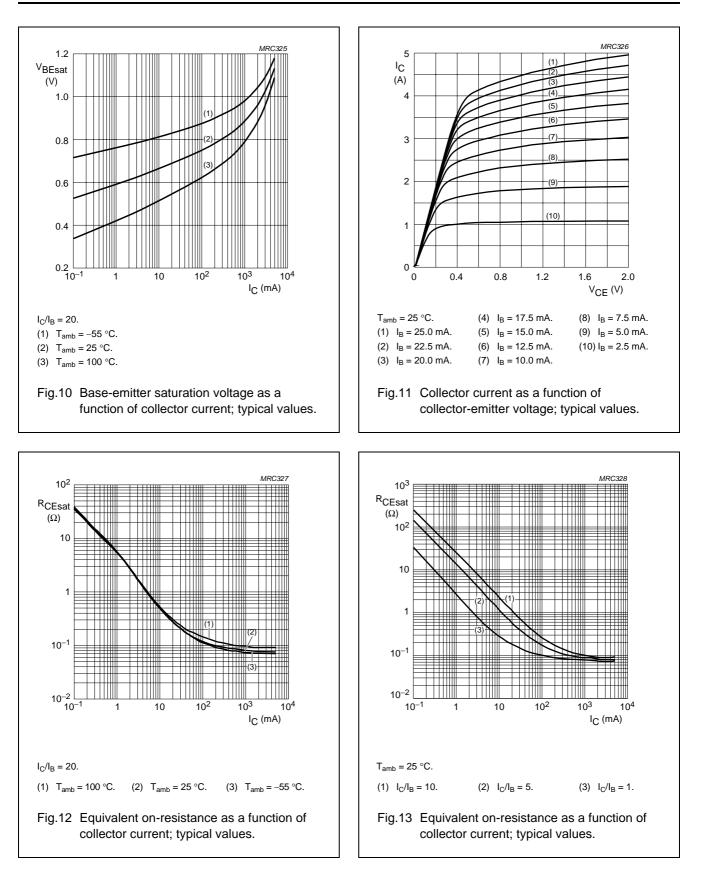
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 30 V; I _E = 0 A	-	_	100	nA
		$V_{CB} = 30 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	-	50	μA
I _{CES}	collector-emitter cut-off current	V _{CE} = 30 V; V _{BE} = 0 V	-	-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V				
		I _C = 0.1 A	300	_	_	
		I _C = 0.5 A	300	_	-	
		I _C = 1 A; note 1	270	_	700	
		I _C = 2 A; note 1	230	_	_	
		I _C = 3 A; note 1	180	_	_	
V _{CEsat}	collector-emitter saturation	I _C = 0.5 A; I _B = 50 mA	_	_	60	mV
	voltage	I _C = 1 A; I _B = 50 mA	_	_	110	mV
		I _C = 2 A; I _B = 100 mA	_	_	220	mV
		I _C = 3 A; I _B = 300 mA; note 1	_	_	300	mV
R _{CEsat}	equivalent on-resistance	I _C = 3 A; I _B = 300 mA; note 1	_	80	100	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 2 A; I _B = 100 mA	-	—	1.1	V
		I _C = 3 A; I _B = 300 mA; note 1	-	—	1.2	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C = 1 A	1.0	_	_	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 5 V; f = 100 MHz	100	-	_	MHz
Cc	collector capacitance	V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz	-	_	30	pF

Note

1. Pulse test: $t_p \leq 300~\mu\text{s};~\delta \leq 0.02.$

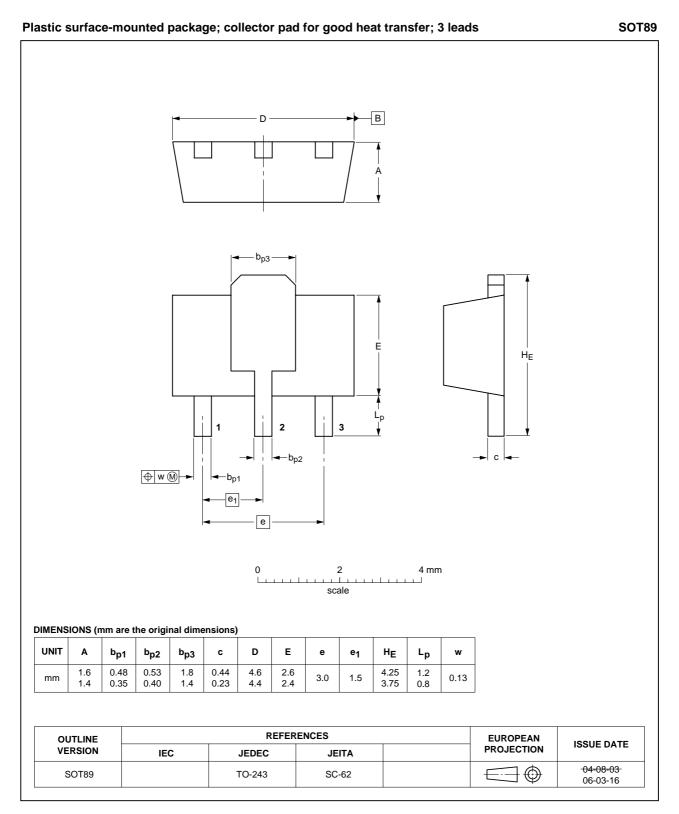




30 V, 3 A NPN low V_{CEsat} (BISS) transistor

PBSS4330X

PACKAGE OUTLINE



PBSS4330X

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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